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| Title        | ペロブスカイト太陽電池の大気圧下における作製プロセスの開発   |
| Author(s)    | 寺井, 篤史  |
| Citation     |   |
| Issue Date   | 2017-03   |
| Type         | Thesis or Dissertation  |
| Text version | none  |
| URL          | <a href="http://hdl.handle.net/10119/14192">http://hdl.handle.net/10119/14192</a> |
| Rights       |   |
| Description  | Supervisor:村田 英幸, マテリアルサイエンス研究科, 修士   |

# Development of Fabrication Process of Perovskite Solar Cells under atmospheric pressure

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## **1. Introduction**

Perovskite solar cells attracted a great deal of attention as solar cells whose power conversion efficiency (PCE) is competitive to that of silicon solar cells<sup>[1]</sup>. Perovskite solar cells have strong light absorption capability and high output voltage and therefore realize the high efficiency<sup>[2]</sup>. In addition, perovskite solar cells have a potential to significantly reduce the production costs, because the devices can be fabricated by simple method such as a spin-coating method and a dip-coating method under atmospheric pressure. However, fabrication of the metal electrodes is generally carried out by using a vacuum deposition, which requires an expensive equipment and a long tact time. In order to reduce the production cost and the tact time, it is necessary to develop simple and low cost techniques to fabricate the electrode under atmospheric pressure. Recently, several techniques have been developed for the fabrication of electrode under of atmospheric pressure such that Ag nanowires<sup>[3]</sup>, Ni mesh/PEDOT:PSS<sup>[4]</sup> or carbon nanotube networks<sup>[5]</sup> as the top electrode. However, the fabrication of these electrodes requires complicated processes with high cost. On the other hand, our group reported that lamination of gold leaf as a top electrode is promising candidate to reduce the cost and tact time to fabricate the electrode for bulk hetero-junction organic solar cells<sup>[6]</sup>. The PCE of the device using Au leaf electrode approached that of the device using vacuum-evaporated Au electrode. This suggests that, Au leaf electrode formed under optimized lamination conditions can reach the equivalent performance as the device with Au electrode by vacuum deposition. In this study, we applied the Au leaf electrode for perovskite solar cells and investigated the effect of the lamination on the performance of perovskite solar cells. The process temperature and the number of lamination processing were investigated during the lamination process. By forming the electrode with the lamination process, we observed that the crystallinity perovskite effectively improved and the device performance enhanced. We also found that the power conversion efficiency strongly depend on the contact area

## **2. Methods**

### **2.1 Device fabrication**

The schematic of the lamination process and device architecture are shown in Figs. 1a and 1b, respectively. A compact TiO<sub>2</sub> layer was formed as follows. First, a 0.15M of TiO<sub>2</sub> solution was spin-coated on a cleaned ITO/glass substrate followed by annealing at 130 °C for 5 min in a glove box. Second, a 0.3M of TiO<sub>2</sub> solution was spin-coated on the TiO<sub>2</sub> film followed by annealing at 130 °C for 5 min in a glove box. This process was repeated twice. Finally, the TiO<sub>2</sub> layers were annealed at 500 °C for 20 min in air. Then, a mesoporous-TiO<sub>2</sub> layer was formed by spin-coating of TiO<sub>2</sub> suspension solution on the compact TiO<sub>2</sub> layer in the glove box and annealed at 500 °C for 30 min in air. A PbI<sub>2</sub> solution was spin-coated on the TiO<sub>2</sub> layer

and followed by annealing at 70 °C for 1 hour in the glove box. After the annealing of the  $\text{PbI}_2$  layer, the substrate was immersed in  $\text{CH}_3\text{NH}_3\text{I}$  solution using IPA as a solvent and then annealed at 70 °C for 1 hour in the glove box. Spiro-OMeTAD solution was spin-coated on the  $\text{CH}_3\text{NH}_3\text{PbI}_3$  perovskite and then annealed at 70 °C for 30 min. Au leaf (c.a.100 nm) or evaporated Au (100 nm) were used as the Au electrodes of the devices.

For the device with the evaporated the Au electrode, annealing under the pressure with a roller was carried out. Conditions of annealing under the pressure such as the roller speed and the the applied pressure ( $P_{\text{roll}}$ ) were  $0.63 \text{ cm sec}^{-1}$  and 0.1 MPa. The roller temperature ( $T_{\text{roll}}$ ) was changed 100 and 150 °C. Number of lamination processing ( $N_{\text{lam}}$ ) was 3 times. Area of the Au electrode was  $0.04 \text{ cm}^2$ .

The lamination process was carried out to form the Au leaf electrode. The lamination conditions such as the lamination speed and the lamination pressure ( $P_{\text{lam}}$ ) were  $0.63 \text{ cm sec}^{-1}$  and 0.1 MPa. The condition of the roller temperature ( $T_{\text{roll}}$ ) was changed 70, 100 and 150 °C. Number of lamination processing ( $N_{\text{lam}}$ ) varied 3, 5 and 10 times. Area of the Au leaf electrode was  $0.25 \text{ cm}^2$ .

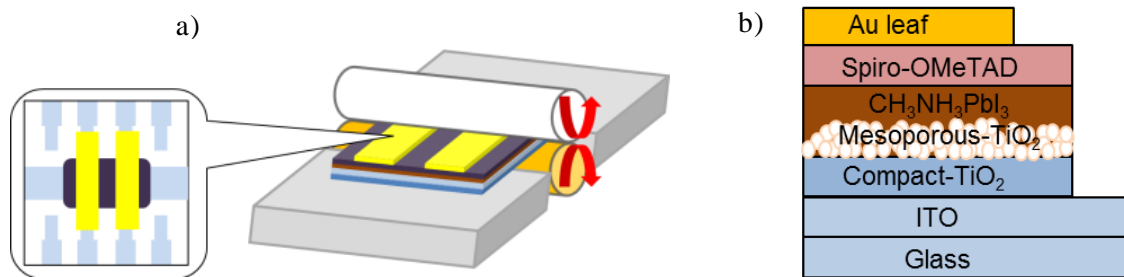


Fig. 1 a) The lamination process b) The device architecture

## 2.2 Characterization

The current density-voltage ( $J$ - $V$ ) curve of the devices was measured by a source meter (2400, Keithley) under irradiating AM 1.5 simulated sunlight ( $100 \text{ mW/cm}^2$ ). The contact area ratio was measured by the color 3D laser microscopy (VK-9710, Keyence).

## 3. Results and discussion

### 3.1 Effect of process temperature on the device performance

Figure 2 shows the  $J$ - $V$  curves of the devices and the device performances are summarized in Table 1. Fig. 3 shows image of Au leaf surface at each process temperature. Power conversion efficiency of the devices with evaporated Au electrode were improved by annealing under the pressure. This would be due to the improvement of the crystallinity perovskite<sup>[7]</sup>. Similar improvement of the device performances was observed in the devices with Au leaf electrode. However, PCEs of the devices with Au leaf electrode were lower than those of the devices with evaporated Au electrode. Since Series resistance ( $R_s$ ) of the device with Au leaf electrode was about three times higher than that with evaporated Au electrode. Adhesion

between Au leaf electrode and hole transport layer (HTL) is worse in comparison with that between evaporated Au electrode and HTL. As increasing the process temperature, the contact area ratio of between Au leaf electrode and HTL increased from 26.51% to 58.11%.

The highest performances of the devices with Au leaf electrode was observed at the lamination temperature of 150 °C. On contrary, performances of the devices with evaporated Au electrode was maximized at 100 °C. This result suggests that the device performances with Au leaf electrode was governed by the adhesion area than that the effect of annealing under pressure to the perovskite layer. Therefore, in the following study, we attempted to improve the contact area ratio by increasing the number of lamination processing while keeping the roller temperature constant at 100 °C.

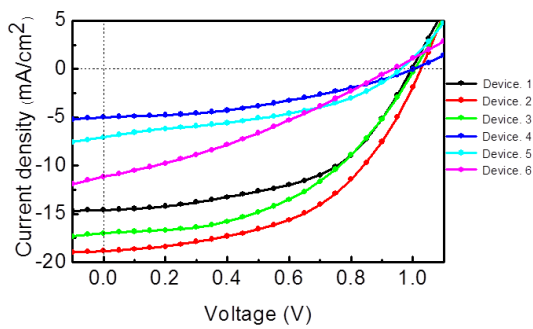


Fig. 2 Effect of process temperature

Table 1 Summary of device performance

| Device No. | Electrode | $T_{101}$ (°C) | $J_{sc}$ (mA/cm <sup>2</sup> ) | $V_{oc}$ (V) | $FF$ | $R_s$ ( $\Omega \cdot \text{cm}^2$ ) | Contact Area (%) | $PCE$ (%) |
|------------|-----------|----------------|--------------------------------|--------------|------|--------------------------------------|------------------|-----------|
| 1          | Eva. Au   | —              | 14.61                          | 1.04         | 0.51 | 18.8                                 | 100              | 7.68      |
| 2          | Eva. Au   | 100            | 18.71                          | 1.03         | 0.50 | 16.9                                 | 100              | 9.53      |
| 3          | Eva. Au   | 150            | 16.97                          | 1.00         | 0.48 | 19.7                                 | 100              | 8.15      |
| 4          | Au leaf   | 70             | 4.64                           | 1.02         | 0.31 | 77.1                                 | 26.51            | 1.90      |
| 5          | Au leaf   | 100            | 6.92                           | 0.93         | 0.38 | 73.3                                 | 47.12            | 2.80      |
| 6          | Au leaf   | 150            | 10.68                          | 0.97         | 0.32 | 66.5                                 | 58.11            | 3.21      |

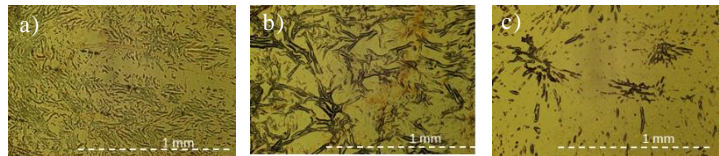


Fig. 3 image of Au leaf surface at (a) 70 °C (b) 100 °C (c) 150 °C

### 3.2 Effect of number of lamination processing on the device performance

Figure 4 shows the  $J$ - $V$  curves of the devices and the device performances are summarized in Table 2. Figure 5 shows image of Au leaf surface at each number of lamination processing.

By increasing the number of lamination processing while keeping the roller temperature constant at 100 °C, the device performances were improved. When the number of lamination processing was 10 times,  $J_{sc}$  was greatly increased and  $R_s$  was decreased. This would be due to the contact area was increased. As a result,  $PCE$  of 4.44% and contact area ratio of 79.60% was obtained.

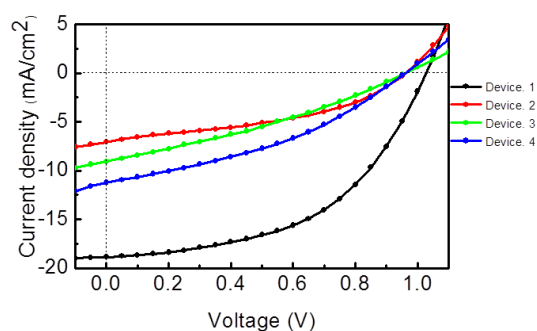


Fig. 4 Effect of number of lamination processing

Table 2 Summary of device performance

| Device No. | Electrode | $N_{lam}$ (times) | $T_{roll}$ (°C) | $J_{sc}$ (mA/cm <sup>2</sup> ) | $V_{oc}$ (V) | $FF$ | $R_s$ ( $\Omega \cdot cm^2$ ) | Contact Area (%) | $PCE$ (%) |
|------------|-----------|-------------------|-----------------|--------------------------------|--------------|------|-------------------------------|------------------|-----------|
| 1          | Eva. Au   | 3                 | 100             | 18.71                          | 1.03         | 0.50 | 16.9                          | 100              | 9.53      |
| 2          | Au leaf   | 3                 | 100             | 6.93                           | 1.00         | 0.40 | 70.60                         | 47.12            | 2.65      |
| 3          | Au leaf   | 5                 | 100             | 8.98                           | 0.96         | 0.32 | 61.95                         | 66.18            | 2.77      |
| 4          | Au leaf   | 10                | 100             | 11.76                          | 0.96         | 0.39 | 39.64                         | 79.60            | 4.44      |

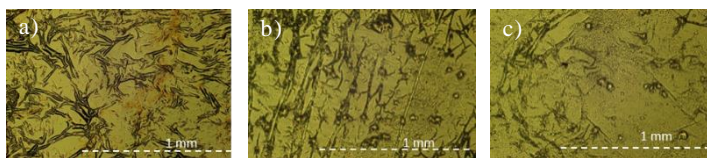


Fig. 5 image of Au leaf surface at (a) 3 times (b) 5 times (c) 10 times

#### 4. Conclusions

Perovskite solar cells was fabricated with using Au leaf as top electrode. The lamination conditions of the roller temperature and number of lamination processing were optimized. As the roller temperature increases, device performance was improved. However, in contrast to the results of the devices with the evaporated Au electrode, the device with Au leaf electrode reached the maximized PCE by the lamination at 150 °C. This suggests that the influence of the contact area ratio of between the Au leaf and HTL on the device performance is dominant. When the roller temperature was 100 °C and number of lamination processing was 10 times, PCE of 4.44% and contact area ratio of 79.60% was obtained.

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